

## PATENT ASSIGNMENT

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>An-Hung Lin</td> <td>05/04/2011</td> </tr> <tr> <td>Hong-Ze Lin</td> <td>05/04/2011</td> </tr> <tr> <td>Bo-Jui Huang</td> <td>05/04/2011</td> </tr> <tr> <td>Wei-Shan Liao</td> <td>05/04/2011</td> </tr> <tr> <td>Ting-Zhou Yan</td> <td>05/04/2011</td> </tr> <tr> <td>Kun-Yi Chou</td> <td>05/04/2011</td> </tr> <tr> <td>Chun-Wei Chen</td> <td>05/04/2011</td> </tr> </tbody> </table>		Name	Execution Date	An-Hung Lin	05/04/2011	Hong-Ze Lin	05/04/2011	Bo-Jui Huang	05/04/2011	Wei-Shan Liao	05/04/2011	Ting-Zhou Yan	05/04/2011	Kun-Yi Chou	05/04/2011	Chun-Wei Chen	05/04/2011
Name	Execution Date																
An-Hung Lin	05/04/2011																
Hong-Ze Lin	05/04/2011																
Bo-Jui Huang	05/04/2011																
Wei-Shan Liao	05/04/2011																
Ting-Zhou Yan	05/04/2011																
Kun-Yi Chou	05/04/2011																
Chun-Wei Chen	05/04/2011																
RECEIVING PARTY DATA																	
Name:	UNITED MICROELECTRONICS CORP.																
Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park																
City:	Hsin-Chu City																
State/Country:	TAIWAN																
PROPERTY NUMBERS Total: 1																	
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14044885</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14044885												
Property Type	Number																
Application Number:	14044885																
CORRESPONDENCE DATA																	
Fax Number:	(703)997-4517																
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>																	
Phone:	3027291562																
Email:	Patent.admin.uspto.cr@naipo.com																
Correspondent Name:	WINSTON HSU																
Address Line 1:	P.O.BOX 506																
Address Line 4:	MERRIFIELD, VIRGINIA 22116																
ATTORNEY DOCKET NUMBER:	NAUP1289USA1																
NAME OF SUBMITTER:	SHELLEY KUO																

CH \$40.00 14044885

Signature:	/SHELLEY KUO/
Date:	10/03/2013
Total Attachments: 3 source=1766841#page1.tif source=1766841#page2.tif source=1766841#page3.tif	

**ASSIGNMENT OF INVENTION**

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

**ASSIGNOR(S) (Inventors):**

Name: An-Hung Lin Nationality: TW

Name: Hong-Ze Lin Nationality: TW

Name: Bo-Jui Huang Nationality: TW

Name: Wei-Shan Liao Nationality: TW

Name: Ting-Zhou Yan Nationality: TW

Name: Kun-Yi Chou Nationality: TW

Name: Chun-Wei Chen Nationality: TW

Hereby sells, assigns and transfers to

**ASSIGNEE(S):**

Name: UNITED MICROELECTRONICS CORP.

Address: No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City 300, Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"LATERAL-DIFFUSED METAL OXIDE SEMICONDUCTOR DEVICE (LDMOS) AND  
FABRICATION METHOD THEREOF"

PATENT

Which is found in :

- (a) + U.S. patent application executed on even date
- (b) \_\_\_\_\_ U.S. patent application executed on \_\_\_\_\_
- (c) \_\_\_\_\_ U.S. application serial no. \_\_\_\_\_
- (d) \_\_\_\_\_ patent no. \_\_\_\_\_ issued \_\_\_\_\_
- (e) \_\_\_\_\_ International application no. \_\_\_\_\_

PATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this MAY 04 2011 (Date of signing). (請聲明人務必簽署上列日期。)

(Type name of inventor)

Signature of INVENTOR

An-Hung Lin

An-Hung Lin

Hong-Ze Lin

Hong-Ze Lin

Bo-Jui Huang

Bo Jui Huang

Wei-Shan Liao

Wei-Shan Liao

Ting-Zhou Yan

Ting-Zhou Yan

Kun-Yi Chou

Kun-Yi Chou

Chun-Wei Chen

Chun-Wei Chen